

# dsPIC33CH128MP508 Family Silicon Errata and Data Sheet Clarification

The dsPIC33CH128MP508 family devices that you have received conform functionally to the current device data sheet (DS70005319**E**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the dsPIC33CH128MP508 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (B0).

Data sheet clarifications and corrections start on page 14, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

- 1. Using the appropriate interface, connect the device to the hardware debugger.
- 2. Open an MPLAB IDE project.
- 3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
- 4. Based on the version of MPLAB IDE you are using, do one of the following:
  - For MPLAB IDE 8, select <u>Programmer ></u> Reconnect.
  - b) For MPLAB X IDE, select <u>Window > Dashboard</u> and click the **Refresh Debug Tool**Status icon ( ).
- Depending on the development tool used, the part number and Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various dsPIC33CH128MP508 silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREY VALUES

Part Number	Device ID <sup>(1)</sup>	Revision ID for	Silicon Revision
Part Number	Device ID(*)	A2	В0
Main (With CAN FD)	·	•	
dsPIC33CH64MP502	0x8740		
dsPIC33CH128MP502	0x8750	7	
dsPIC33CH64MP503	0x8741	0x0002 0	
dsPIC33CH128MP503	0x8751		
dsPIC33CH64MP505	0x8742		0000
dsPIC33CH128MP505	0x8752		0x0003
dsPIC33CH64MP506	0x8743	7	
dsPIC33CH128MP506	0x8753		
dsPIC33CH64MP508	0x8744		
dsPIC33CH128MP508	0x8754	7	

Note 1: The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".

TABLE 1: SILICON DEVREV VALUES (CONTINUED)

Dout Namehou	Device ID <sup>(1)</sup>	Revision ID for	Silicon Revision
Part Number	Device ID(*)	A2	В0
Secondary (With CAN FD)	·		
dsPIC33CH64MP502S1	0x87C0		
dsPIC33CH128MP502S1	0x87D0		
dsPIC33CH64MP503S1	0x87C1	7	
dsPIC33CH128MP503S1	0x87D1	7	
dsPIC33CH64MP505S1	0x87C2	0x0002	0x0003
dsPIC33CH128MP505S1	0x87D2	UXUUU2	0x0003
dsPIC33CH64MP506S1	0x87C3		
dsPIC33CH128MP506S1	0x87D3		
dsPIC33CH64MP508S1	0x87C4		
dsPIC33CH128MP508S1	0x87D4		1
Main (Without CAN FD)			
dsPIC33CH64MP202	0x8700		0x0003
dsPIC33CH128MP202	0x8710		
dsPIC33CH64MP203	0x8701	0x0002	
dsPIC33CH128MP203	0x8711		
dsPIC33CH64MP205	0x8702		
dsPIC33CH128MP205	0x8712	0x0002	
dsPIC33CH64MP206	0x8703		
dsPIC33CH128MP206	0x8713		
dsPIC33CH64MP208	0x8704		
dsPIC33CH128MP208	0x8714		
Secondary (Without CAN FD)			
dsPIC33CH64MP202S1	0x8780		
dsPIC33CH128MP202S1	0x8790		
dsPIC33CH64MP203S1	0x8781		
dsPIC33CH128MP203S1	0x8791		
dsPIC33CH64MP205S1	0x8782	0x0002	0x0003
dsPIC33CH128MP205S1	0x8792	0,0002	0,0003
dsPIC33CH64MP206S1	0x8783		
dsPIC33CH128MP206S1	0x8793		
dsPIC33CH64MP208S1	0x8784		
dsPIC33CH128MP208S1	0x8794		

**Note 1:** The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".

TABLE 2: SILICON ISSUE SUMMARY

Module Feature	Feature	ture Item Number	Issue Summary		cted sions
		Number		A2	В0
ECC	Status	1.	ECCSTATH/L registers cannot be read.	Х	
ECC	Status	2.	SECSYNDx bits in the ECCSTATH register cannot be read.	Χ	
I2C	Interrupt	3.	In Client mode, an incorrect interrupt is generated with DHEN = 1.	Х	Х
I2C	Error	4.	Bus collision error cannot be cleared.	Χ	Χ
I2C	Error	5.	False bus collision error generated.	Χ	Х
I2C	Idle	6.	Address cannot be received in Idle mode.	Χ	Χ
Oscillator	PLL	7.	FRCDIVN drives the PLL instead of the FRC.	Χ	Χ
Oscillator	HS, XT	8.	Removed		
PWM	Dead Time	9.	When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.	Х	Х
UART	OERR	10.	The OERR bit cannot be cleared by software.	Χ	Χ
UART	FERR	11.	The FERR bit will not get set if one Stop bit is received.	Χ	Х
UART	OERR	12.	The 9th byte received will not be available to be read.	Χ	Х
UART	TRMT	13.	The TRMT bit takes time to set on the last transmit completion.	Χ	Χ
UART	TRMT	14.	The TRMT bit is unreliable when there is back-to-back Break character transmission.	Х	Х
UART	Idle	15.	SLPEN = 1 will not keep the UART BRG clock active in Sleep mode.	Х	Х
UART	RIDLE	16.	The RIDLE bit takes one instruction cycle to get cleared after ABAUD is set.	Х	Х
UART	TXWRE	17.	The TXWRE bit (UxSTAH[7]) cannot be cleared once it gets set.	Х	Х
UART	Address Detect	18.	When writing to UxP1 with UTXBRK = 1, the content of P1 will not get transmitted.	Х	Х
UART	DMX	19.	Removed.		
UART	DMX	20.	Removed.		
UART	Smart Card	21.	The Waiting Time Counter Interrupt Flag (WTCIF) is set when the last x character transmitted has the bit, LAST = 0.	Х	Х
UART	XOFF	22.	XOFF is transmitted when one empty space remains in the RX buffer.	Х	Х
CPU	FLIM Instruction	23.	When the operands are of different signs, the FLIM instruction may not force the correct data limit.	Х	Х
SCCP/MCCP	Clock Source	24.	Using Fosc as the clock source may cause synchronization issues.	Х	Х
I2C	SMBus 3.0	25.	When Configuration bit, SMBEN (FDEVOPT[10]) = 1, the SMBus 3.0 VIH minimum specification may not be met.	Х	Х
I/O	POR	26.	Spike on I/O at POR.	Х	
CPU	MAXAB/MINAB	27.	When the operands are of different signs, the MAXAB, MINAB and MINZAB instructions may not output the correct value.	Х	Х
CPU	div.sd Instruction	28.	When using the signed 32-by-16-bit division instruction, div.sd, the Overflow bit is not getting set when an overflow occurs.	Х	Х
DMA	ADC Triggers	29.	DMA is triggered continuously from ADC.	Х	
PWM	Time Base Capture	30.	PWM Capture Status (CAP) flag will not set again under certain conditions.	Х	Х

# TABLE 2: SILICON ISSUE SUMMARY (CONTINUED)

Module Feature		Item	Issue Summary		Affected Revisions	
		Number	-	A2	В0	
I2C	I <sup>2</sup> C	31.	All instances of I <sup>2</sup> C may exhibit errors and should not be used.	Х		
Oscillator	VCO and AVCO Dividers	32.	Main and auxiliary PLL external VCO dividers can fail to output the clock signal.	Х		
Main Secondary Interface (MSI)	DMA Transfer	33.	DMA transfer of mailbox data.	Х	Х	
Secondary CPU	REPEAT	34.	REPEAT loops interrupted by nested interrupts on the Secondary core may corrupt data and trap.	Х	Х	
UART	TXWRE	35.	TXWRE bit is not cleared when transmitter is disabled.	Χ	Х	
Secondary CPU	PRAM ECC	36.	Secondary core CPU may read from unprogrammed PRAM location.	Х	Х	
SCCP	CCP Timer Interrupt	37.	In Capture mode, the CCPx Timer Interrupt, _CCTxInterrupt, may not occur if the Timer Prescale (TMRPS[1:0]) value is not configured for 1:1 operation.	Х	Х	
ADC	Differential- Mode	38.	When using ADC in Differential-mode (DIFFx = 1) with input frequency (FSRC) above 50 MHz, the first result data may be incorrect.	Х	Х	
POR	ECC	39.	During power-up (POR Reset), an ECC trap or interrupt may occur.	Х	Х	

#### Silicon Errata Issues

Note:

This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**B0**).

## 1. Module: ECC

The ECCSTATH/L registers cannot be read when an ECC error happens. The ECC Double-Bit Error (ECCDBE) trap and ECC Single Bit Error (ECCSBE) interrupt will work correctly, but the ECCSTATH/ECCSTATL registers will always read as zero.

#### Work around

None.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х		
Secondary			

#### 2. Module: ECC

In the ECCSTATH register, the SECSYNDx bits cannot be read when an ECC error happens.

# Work around

None.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main			
Secondary	Х		

# 3. Module: I<sup>2</sup>C

In Client mode with DHEN = 1 (Data Hold Enable), if software sends a NACK, a Client interrupt is asserted at the 9th falling edge of the clock.

# Work around

Software should ignore the Client interrupt that is asserted after sending a NACK.

# **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

# 4. Module: I<sup>2</sup>C

In Client mode, the Bus Collision Detect (BCL) bit cannot be cleared when bus collision detection is enabled (SBCDE = 1).

#### Work around

Disable the  $I^2C$  module and then re-enable the module.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

# 5. Module: I<sup>2</sup>C

In Client mode, false bus collision triggers are generated when the bus collision is enabled (SBCDE = 1) and a Stop bit is received.

#### Work around

Ignore the bus collision. Disable the I<sup>2</sup>C module and then re-enable the module.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondar	/ X	Х	

# 6. Module: I<sup>2</sup>C

In Client mode, an address cannot be received when the device is in Idle and the module is set for discontinue in Idle (I2CSIDL = 1).

### Work around

None.

Core	A2	В0	
Main	Х	Х	
Secondary	Χ	Χ	

#### 7. Module: Oscillator

When using the 8 MHz internal FRC Oscillator with Primary PLL as either a system clock or a peripheral source, FRCDIVN drives the PLL instead of the FRC.

This means that the PLL FRC input selection is subject to the FRCDIV[2:0] bits and could lead to a condition where the minimum PLL input requirement of 8 MHz is not maintained.

#### Work around

Ensure FRCDIV[2:0] bits are maintained as zero when using FRCPLL as either a system clock or a peripheral source.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

#### 8. Module: Oscillator

This errata is no longer applicable to any silicon revisions of this product. See **Section 2.5** "**External Oscillator Pins**" in the current device data sheet (DS70005319**D**) for guidance on oscillator design to avoid start-up related issues.

#### 9. Module: PWM

When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.

#### Work around

Use Sync PCI (DTCMPSEL = 0) for dead-time compensation.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Χ	Х	

#### 10. Module: UART

Once the UART receive buffer overflows and the OERR bit (UxSTA[1]) is set, the OERR bit cannot be cleared by software.

#### Work around

Make sure that the receive buffer never overflows. Do not let the OERR bit get set by reading the received data byte on each byte reception.

#### Affected Silicon Revisions

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

#### 11. Module: UART

When the UART is operating with STSEL[1:0] = 2 (two Stop bits sent, two checked at receive), the FERR bit will not get set if one Stop bit is received.

#### Work around

Use STSELx = 3 instead of STSELx = 2. When operating with STSELx = 3 mode, the UART will be configured to send two Stop bits, but check one at receive.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

### 12. Module: UART

When the receive buffer overflows, the 9th byte received will get lost and cannot be read.

#### Work around

Do not allow the OERR bit to get set by reading the received data byte on each byte reception.

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

#### 13. Module: UART

At low BRG value, the TRMT bit takes time to set on the last transmit completion, which may result in the transmitted data getting lost.

#### Work around

- Use the UTXBE bit to monitor for the next transmit.
- 2. Provide a delay to stabilize the POSC.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Χ	Х	

#### 14. Module: UART

The Transmit Shifter Empty (TRMT) bit is unreliable when there is back-to-back Break character transmission.

#### Work around

Poll the UART Transmit Break bit, UTXBRK (UxMODE[8]), to be cleared instead of the TRMT bit.

### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

#### 15. Module: UART

UART will not work correctly in Sleep mode. SLPEN = 1 will not keep the UART baud rate clock active in Sleep mode.

#### Work around

None.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

#### 16. Module: UART

During a UART Auto-Baud Detection sequence, the RIDLE bit takes one instruction cycle to get cleared after ABAUD is set.

#### Work around

Ignore the RIDLE bit until the Auto-Baud Detection sequence is complete.

#### Affected Silicon Revisions

Core	A2	В0	
Main	Χ	Х	
Secondary	X	Х	

#### 17. Module: UART

Once the TX Write Transmit Error Status bit, TXWRE (UxSTAH[7]), gets set, the TXWRE cannot be cleared by a single clear instruction.

#### Work around

Use multiple clear instructions of loop until the TXWRE bit gets cleared.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Χ	Х	

# 18. Module: UART

In UART Address Detect mode, writing to UxP1 with UTXBRK = 1 should cause a Break to be transmitted, followed by the content in P1, but the content of P1 will not get transmitted.

#### Work around

After writing to P1, wait for UTXBRK to get clear and then rewrite to P1.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	X	Х	

#### 19. Module: UART

This errata is no longer applicable to any silicon revisions of this product.

#### 20. Module: UART

This errata is no longer applicable to any silicon revisions of this product.

#### 21. Module: UART

In Smart Card T = 1 mode, the Wait Time Counter Interrupt Flag (WTCIF) is set when the last character transmitted has the LAST bit = 0.

#### Work around

Ignore WTC interrupt events on non-last bytes.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Χ	Х	

#### 22. Module: UART

In Software Flow Control mode, XOFF is transmitted when one empty space remains in the RX buffer. XOFF transmission can get further delayed if the transmitter has already been loaded, resulting in XOFF transmission on a receive buffer full event.

#### Work around 1

Give a minimum one-byte delay before each byte transmission.

#### Work around 2

Use the UART RX interrupt with URXISEL[2:0] set to at least two empty slots. This allows the RX buffer to be read in time to prevent RX buffer overflow.

#### Affected Silicon Revisions.

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

#### 23. Module: CPU

The FLIM instruction may incorrectly limit the data range when operating on signed operands of different sign values. If the operands are either all negative or all positive, the limit is correct.

# Work around

None.

### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Χ	

#### 24. Module: SCCP/MCCP

When Fosc is selected as the clock source using the CLKSEL[2:0] bits (CCPxCON1L[10:8]), unexpected operation may occur. For proper SCCP/MCCP input clock synchronization, do not use Fosc as the system clock source.

#### Work around

Use any of the other available clock sources in CLKSEL[2:0].

# **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

# 25. Module: I<sup>2</sup>C

When selecting SMBus 3.0 operation using Configuration bit, SMBEN (FDEVOPT[10]), the Voltage Input High (VIH) of the SMBus 3.0 specification minimum may not be met.

#### Work around

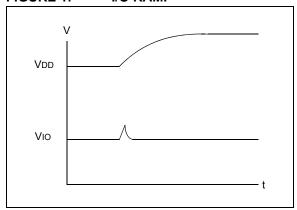
None.

Core	A2	В0	
Main	Χ	Х	
Secondary	Χ	Х	

#### 26. Module: I/O

During a fast device power-up, when the VDD ramp is less than 4 mS, the I/O pins may drive up to 100  $\mu$ A current for a duration of up to 10  $\mu$ S (Figure 1).

FIGURE 1: I/O RAMP



#### Work around

- Slow down the VDD ramp time (greater than 4 mS for VDD to ramp 0V to 3.3V).
- 2. Ensure the circuitry that is connected to the pins can endure this pulse.

Example applications affected may include complementary power switches, where a transient current shoot-through might occur.

High-voltage applications with complementary switches should power the high-voltage 200  $\mu$ Sec later than powering the dsPIC<sup>®</sup> device to avoid the current shoot-through. This behavior is specific to each device and not affected by aging.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ		
Secondary	Х		

#### 27. Module: CPU

When operating on signed operands of different sign values, the output for MAXAB, MINAB and MINZAB instructions may be incorrect. If the operands are either all negative or all positive, the output is correct.

#### Work around

None.

# **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

#### 28. Module: CPU

When using the Signed 32-by-16-Bit Division instruction, DIV.SD, the Overflow bit may not always get set when an overflow occurs. This erratum only affects operations in which at least one of the following conditions is true:

- · Dividend and divisor differ in sign,
- Dividend > 0x3FFFFFF or
- Dividend < 0xC0000000

#### Work around

The application software must perform both of the following actions to handle possible undetected overflow conditions:

- a) The value of the dividend must always be constrained to be in the following range: 0xC0000000 ≤ Dividend ≤ 0x3FFFFFFF.
- b) If the dividend and divisor differ in sign (e.g., dividend is negative and divisor is positive), then after executing the DIV.SD instruction or the compiler built-in function, \_\_builtin\_divsd(), inspect the sign of the resultant quotient. If the quotient is found to be a positive number, then treat it as an overflow condition.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

#### 29. Module: DMA

The DMA receives multiple continuous triggers from the ADC until the trigger event from ADC is cleared. The OVRUNIF flag (DMAINTn[3]) will be set. When the OVRUNIF bit changes state, from '0' to '1', a DMA interrupt is generated.

#### Work around

Ignore the OVRUNIF bit and the first DMA interrupt. Clear the ADC trigger source, ANxRDY, with a DMA read of the ADC buffer, ADCBUFx, for the corresponding ADC channel.

Core	A2	В0	
Main	Χ		
Secondary	Х		

#### 30. Module: PWM

When using a PWM Control Input (PCI) to trigger a time base capture, the Capture Status flag, CAP (PGxSTAT[5]), may not set again under certain conditions. When a subsequent PWM capture event occurs while, or just after, reading the current capture value from the PGxCAP register, the Capture Status flag, CAP, will not set again.

#### Work around

Read the PWM Generator Capture (PGxCAP, x = 1 to 8) register at a known time to avoid the condition. The timing of the PGxCAP read operation can be scheduled by using the PWM Generator (1-8) interrupt, or any of the six PWM Event (A-F) interrupts, corresponding to the PCI event which triggered the time base capture. Read the PGxCAP value after the CAP bit has been set within the interrupt.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ	Х	
Secondary	Χ	Х	

# 31. Module: I<sup>2</sup>C

All instances of I $^2$ C/SMBus may exhibit errors and should not be used. When operating I $^2$ C/SMBus in a noisy environment, the I $^2$ C module may exhibit various errors. These errors may include, but are not limited to, corrupted data, unintended interrupts or the I $^2$ C bus getting hung up due to injected noise. Examples of system noise include, but are not limited to, PWM outputs or other pins toggled at high speed adjacent to the I $^2$ C pins. Both Host and Client I $^2$ C/SMBus modes may exhibit this issue.

#### Work around

If I<sup>2</sup>C is required, use a software I<sup>2</sup>C implementation. An example I<sup>2</sup>C software library is available from Microchip:

www.microchip.com/dsPIC33C\_I2C\_SoftwareLibrary

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Χ		
Secondary	Х		

#### 32. Module: Oscillator

At PLL start-up, the main and auxiliary PLL VCO dividers may occasionally halt and not provide a clock output. The VCO and AVCO dividers can be selected as clock sources for different peripheral modules, including the ADC, PWM, DAC, CAN FD, UART, etc.

All VCO and AVCO divider outputs, Fvco/2, Fvco/3, Fvco/4, Fvcopiv, AFvco/2, AFvco/3, AFvco/4 and AFvcopiv, are affected and may show the issue independently.

Any type of Reset may recover the VCO/AVCO divider clock outputs (Software Reset, WDT, MCLR or POR).

#### Work around 1

Use another clock source, such as the Fosc, PLL or APLL output (FPLLO and AFPLLO), instead of the VCO or AVCO dividers.

#### Work around 2

If the application requires the VCO/AVCO divider, peripheral activity should be verified within some time or the device should be Reset.

The Watchdog Timer (WDT) or Timer1 may be used to establish the time-out period and reset the device. The following steps may be taken to implement this work around for any given peripheral and VCO/AVCO divider combination.

- 1) Set up the WDT or Timer1 time-out period.
- Set up the VCO/AVCO divider source to be used by the peripheral.
- 3) Start the peripheral from this source.
- Verify peripheral activity using an interrupt or other method and disable the time-out.
- 5) If the time-out expires, the device should be Reset; WDT will reset the device without intervention, but Timer1 will require a SWR in the Timer1 Interrupt Service Routine.

Core	A2	В0	
Main	Χ		
Secondary	Х		

## 33. Module: Main Secondary Interface (MSI)

When transferring data between cores using the MSI mailbox with DMA, if the transmitting core is running more than two times the system clock frequency of the receiving core, the data transfer may not be processed correctly and the MSI may appear to be in a Freeze state.

An example of the application includes the DMA in the transmitting core may load data to the MSI Mailbox register after the receiving core initiates the MSI interrupt to Acknowledge data reception, but prior to hardware clear of the DTRDY bit, causing the hardware to appear to be frozen in the state where DTRDY is set in the transmitting core and cleared in the receiving core.

#### Work around

Do not use DMA for MSI data transfer when the core sending data will be operating at more than two times the system clock frequency of the core receiving data. Instead, in the MSI ISR, clear the DTRDY bit and load the next data to the MSI buffer/FIFO directly.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

# 34. Module: Secondary CPU

While the Secondary CPU core is executing the instruction targeted by a REPEAT loop and two or more nestable interrupts occur in near simultaneous proximity, data corruption may occur within the lowest priority Interrupt Service Routine (ISR) and/or original REPEAT loop code. Specifically, when the CPU is vectoring to the lower priority ISR and a higher priority stimulus forces the CPU to vector to a different ISR, hardware will retarget the background REPEAT loop onto the first instruction of the lower priority ISR. Typically, ISRs start with a stack PUSH instruction, resulting in repeated stack pushes later when the lower priority ISR executes. This manifests as an Address Error Trap upon return from the low-priority ISR as the CPU attempts to use the repeated stack push data as the ISR's return address.

If the first instruction of the lower priority ISR is repeatable without harmful effects, such as a NOP, data corruption will still be apparent in the background code as its REPEAT loop will prematurely terminate.

#### Work around 1

Avoid using REPEAT instructions in projects built for the Secondary Core. For compiled code, use MPLAB® XC16, v1.61 or higher and specify -merrata=repeat\_gie or -merrata=repeat\_nstdis as an additional option for XC16 (Global Options). Alternatively, this option may be individually added to the command-lines invoking xc16-gcc and xc16-ld.

-merrata=repeat\_gie will suppress generation of REPEAT loops unless required for a hardware divide instruction. For divides, the REPEAT loop will be prefixed with instructions to save INTCON2. Write GIE (INTCON2[15]) = 0 to globally disable all interrupts, then postfix with an instruction to restore INTCON2. Toolchain library calls, such as memcpy()/printf(), etc., will also link against implementations that avoid REPEAT loops and globally mask interrupts where needed for divide instructions.

-merrata=repeat\_nstdis will also suppress REPEAT loops. However, for hardware divide loops, saving/restoring will be applied to INTCON1 and NSTDIS (INTCON1[15]) = 1 will be written to disable interrupt nesting while maintaining GIE unchanged. Toolchain libraries will continue to use GIE (INTCON2[15]) global interrupt masking instead of relying on NSTDIS (INTCON1[15]) to protect divide loops.

Note:

Blocking interrupt nesting typically adds no latency to interrupt processing, but increases worst-case interrupt latency for higher priority ISRs. A low-priority interrupt triggered immediately before a high-priority stimulus adds the entire execution time of the low-priority ISR to the worst-case response latency for the higher priority ISR.

#### Work around 2

Ensure that all REPEAT instructions only execute in a context where back-to-back interrupts of nestable priority are impossible, such as within IPL6 and IPL7 ISRs, or anywhere all enabled interrupts are known to be configured to the same priority level. Also, if the application implements periodic interrupts corresponding to internal/synchronously timed events, it may be possible to find or wait for an execution window where a REPEAT loop can deterministically complete without two nested interrupts able to clobber it. A PWRSAV call to enter Idle mode may help find synchronized, safe windows as code flow will halt, then resume in response to the next interrupt.

As compiled code can have REPEAT loops hidden within them, this work around should only be attempted on a per source file basis with work around 1 applied for all other files that cannot be carefully controlled or which do not require REPEAT loops. It is additionally suggested that the full project disassembly listing be searched for REPEAT instructions and that proper interrupt masking, nest disabling or contextual state and timing conditions for safe REPEAT execution have been met.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

### 35. Module: UART

The TXWRE bit is not cleared when the UART transmitter is disabled.

### Work around

The user must flush the FIFO via writing TXBE = 1 first and then the TXWRE bit can be cleared.

# **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	Х	Х	

# 36. Module: Secondary CPU

If transferring data using the DMA with DMAPR (MSTRPR[5]) = 1 (DMA priority higher than CPU) and an interrupt occurs, the Secondary CPU, "cpu\_pmem\_addr", may be corrupted with the DMA data before fetching the proper RETFIE return address. If the DMA data correspond to the address of an unprogrammed location in the PRAM, ECC single-bit and double-bit errors may be observed.

#### Work around

A routine, called "\_wipe\_secondary(1);", has been added in MPLAB® XC16 v1.70 or higher and requires the MPLAB IDE device family pack, dsPIC33CH-MP 1.9.207 or higher. This routine will load the PRAM with a known value and valid ECC contents. The Main core application should call this routine at least once each time the device is powered on and should do so before loading the PRAM with the Secondary core user application image.

The time needed to run the "\_wipe\_secondary(1);" routine is Main core execution speed-dependent, but will be similar to loading a full size image to a PRAM of a given size.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main			
Secondary	Х	Х	

# 37. Module: SCCP

In Capture mode, the CCPx Timer Interrupt, \_CCTxInterrupt, may not occur if the Timer Prescale (TMRPS[1:0]) value is not configured for 1:1 operation.

### Work around

If the \_CCTxInterrupt is needed in Capture mode, maintain TMRPS[1:0] = 00 for 1:1 timer prescale.

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

#### 38. Module: ADC

When using ADC in Differential-mode (DIFFx = 1) with Input Frequency (FSRC) above 50 MHz, the first result data may be incorrect. The Single-Ended Channel mode is unaffected by this errata.

#### Work around

Use a slower input frequency of 50 MHz or less for the ADC initialization to write to the ADMODxL/H registers. After completion of the first data conversion of each channel in Differential-mode, the Input Frequency, FSRC, can be increased to the maximum specified frequency in the electrical characteristics.

#### **Affected Silicon Revisions**

Core	A2	В0	
Main	Х	Х	
Secondary	X	Χ	

#### 39. Module: POR

In an extremely rare situation, during power-up (POR Reset), an unintended ECC trap or ECC interrupt may occur.

#### Work around

Any one of the following work arounds can be implemented to resolve the issue:

- Execute a software RESET instruction after a POR Reset. The POR condition can be verified by reading the POR bit (RCON[0]). The POR test and RESET instruction can be located in the generic Hard Trap Service Routine, which contains the ECC double-bit error, as well as in the ECC Single-Bit Error Interrupt Service Routine.
- An external MCLR Reset supervisor circuit can be used to hold the device in Reset during POR and released after the VDD is above 3V.
- 3. Ensure the VDD rise rate is at least 0.03 V/ $\mu$ S (0 to 3.0V in 100  $\mu$ S). VDD rise from 0V to 3.0V minimum operating voltage should take no longer than 100  $\mu$ S.

Core	A2	В0	
Main	Χ	Х	
Secondary	Х	Х	

# **Data Sheet Clarifications**

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70005319**E**):

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

None.

# APPENDIX A: DOCUMENT REVISION HISTORY

# Rev A Document (5/2018)

Initial release of this document; issued for revision A2.

#### Rev B Document (11/2018)

Adds silicon issue 23 (CPU), 24 (SCCP/MCCP), 25 (I2C) and 26 (I/O).

# Rev C Document (10/2019)

Adds silicon issue 27 (CPU), 28 (CPU), 29 (DMA) and 30 (PWM).

Updates silicon issue 26 (I/O).

Updates device data sheet reference to the current revision D.

#### Rev D Document (2/2020)

Adds silicon issue 31 (I2C).

#### Rev E Document (6/2020)

Adds silicon issues 32 (Oscillator) and 33 (Main Secondary Interface (MSI)).

Adds data sheet clarification 1 (Electrical Characteristics).

Removes silicon issue 8 (Oscillator) since it is no longer applicable.

#### Rev F Document (10/2020)

Updates silicon issue 32 (Oscillator).

Adds silicon issue 34 (Secondary CPU).

Adds data sheet clarifications 2 (Functional Safety and Qualification Support), 3 (Guidelines for Getting Started with 16-Bit Digital Signal Controllers) and 4 (dsPIC® Core Naming Convention).

# Rev G Document (12/2020)

Adds silicon revision B0.

Corrects the Features in Table 2 for Silicon Revision 10, 11 and 12.

Removes Work Around #2 from silicon issue 10 (UART).

Removes silicon issues 19 (UART) and 20 (UART) since they are no longer applicable. Please see data sheet clarification 5 (UART) for more information.

Changes the MPLAB® XC16 version to v1.61 or higher.

Adds silicon issue 35 (UART) and 36 (Secondary CPU).

Adds data sheet clarifications 5 (UART), 6 (SPI), 7 (Oscillator), 8 (Electrical Characteristics), 9 (ADC), 10 (DAC), 11 (PTG), 12 (PPS), 13 (Electrical Characteristics), 14 (MSTRPR Register) and 15 (MSTRPR Register).

#### Rev H Document (4/2021)

Updates the workaround for silicon issue 36 (Secondary CPU).

Adds silicon issue 37 (SCCP).

Adds data sheet clarifications 16 (Electrical Characteristics) and 17 (Electrical Characteristics).

#### Rev J Document (8/2021)

Updates silicon issue 36 (Secondary CPU).

Adds silicon issues 38 (ADC) and 39 (POR).

#### Rev K Document (9/2023)

Removes all data sheet clarifications since corrections and clarifications have been included in the latest data sheet revision (DS70005319**E**).

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